## What is claimed is:

- 1. An optoelectronic sensor based on optodes, having a plurality of separate light-sensitive sensors (6) on a semiconductor substrate (10) and a light emitter (1) located in the center, wherein the light emitter (1) and the light-sensitive sensors (6) are covered by a transparent optode material, and the transparent optode material (4) is reflective on the side that faces away from the semiconductor substrate (10).
- 2. The optoelectronic sensor according to Claim 1, wherein reflectivity is created via metal particles that are introduced into the transparent optode material (4).
- 3. The optoelectronic sensor according to Claim 1 or 2, wherein the transparent optode material (4) is covered with an opaque material (9).
- 4. The optoelectronic sensor according to Claim 1, 2, or 3, wherein the transparent optode material (4) is a polymer to which an indicator substance is added.
- 5. The optoelectronic sensor according to Claim 4, wherein the indicator substance has pigment molecules.
- 6. The optoelectronic sensor according to Claim 3, 4 or 5, wherein the opaque material (9) is a polymer.
- 7. The optoelectronic sensor according to one of the preceding claims, wherein the light-sensitive sensors (6) having the sections of the optode material (8) that cover them are arranged as sectors and rotationally symmetrically around the light emitter (1).
- 8. The optoelectronic sensor according to one of the preceding claims, wherein the semiconductor substrate (10) is an n-type silicon substrate and the light-sensitive sensors (6) are made of p-type silicon.
- 9. The optoelectronic sensor according to one of the preceding claims, wherein the light-sensitive sensors (6) form photodiodes and the light emitter is an LED.

- 10. The optoelectronic sensor according to one of the preceding claims, wherein the optode material (4) is designed to detect nitrogen oxides or carbon monoxide.
- 11. The optoelectronic sensor according to one of the preceding claims, wherein the sensor is provided with oxidation means which are provided on a carrier material.
- 12. The optoelectronic sensor according to one of the Claims 1 to 10, wherein the optoelectronic sensor has a molecular sieve.
- 13. The optoelectronic sensor according to one of the preceding claims, wherein the optoelectronic sensor has barriers that are arranged between transmission branches.
- 14. The optoelectronic sensor according to one of the preceding claims, wherein the light emitter (1) can be operated using electrical pulses.
- 15. A gas sensor array according to one of Claims 1 to 14, wherein the optoelectronic sensor is used as the array element.